

Aug 2012

FDD8453LZ_F085

N-Channel Power Trench[®] MOSFET 40V, 50A, 6.5m Ω

Features

- Typ $r_{DS(on)}$ = 5m Ω at V_{GS} = 10V, I_D = 15A
- Typ $r_{DS(on)}$ = 6m Ω at V_{GS} = 4.5V, I_D = 13A
- HBM ESD protection level > 7kv typical
- RoHS Compliant
- Qualified to AEC Q101

General Description

This N-Channel MOSFET is produced using Fairchild Semiconductor's advanced PowerTrench® process that has been especially tailored to minimize the on-state resistance and switching loss. G-S zener has been added to enhance ESD voltage level.

Applications

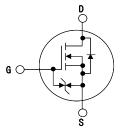
- Inverter
- Synchronous Rectifier



Package



Symbol



MOSFET Maximum Ratings $T_C = 25^{\circ}C$ unless otherwise noted

Symbol	Parameter		Ratings	Units			
V_{DSS}	Drain to Source Voltage		40	V			
V_{GS}	Gate to Source Voltage		±20	V			
ı	Drain Current - Continuous (Package limited) T _C = 25°C		50	Δ.			
I _D	-Pulsed		Figure4	_ A			
E _{AS}	Single Pulse Avalanche Energy ((Note 1)	88	mJ			
D	Power Dissipation		118	W			
P_{D}	Dreate above 25°C		0.79	W/°C			
T_J , T_{STG}	Operating and Storage Temperature		-55 to + 175	°C			

Thermal Characteristics

$R_{\theta JC}$	Thermal Resistance Junction to Case	1.27	°C/W
$R_{\theta JA}$	Thermal Resistance Junction to Ambient, 1in ² copper pad area	52	°C/W

Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size Tape Width		Quantity
FDD8453LZ	FDD8453LZ_F085	D-PAK(TO-252)	13"	12mm	2500 units

Electrical Characteristics T_C = 25°C unless otherwise noted

Symbol	Parameter	Test Conditions	Min	Тур	Max	Units	
Off Cha	Off Characteristics						
B _{VDSS}	Drain to Source Breakdown Voltage	$I_D = 250 \mu A, V_{GS} = 0 V$	40	-	-	V	

B _{VDSS}	Drain to Source Breakdown Voltage	$I_D = 250 \mu A, V_{GS} = 0 V$		40	-	-	V
I _{DSS} Zero Gate Voltage Drain Current		$V_{DS} = 32V$,		-	-	1	^
IDSS Zero Gate Voltage Drain Current	$V_{GS} = 0V$	$T_{\rm C} = 150^{\rm o}{\rm C}$	-	-	250	μΑ	
I _{GSS}	Gate to Source Leakage Current	V _{GS} = ±20V		-	ı	±10	uA

On Characteristics

$V_{GS(th)}$	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}, I_{D} = 250 \mu A$	1.0	1.8	3.0	V
		I _D = 15A, V _{GS} = 10V	-	5.0	6.5	mΩ
r _{DS(on)}	Drain to Source On Resistance	I _D = 13A, V _{GS} = 4.5V	-	6.0	7.8	mΩ
, ,		I _D = 15A, V _{GS} = 10V T _J =175°C	-	9.4	12.2	mΩ
g _{FS}	Forward Transconductance	V _{DS} = 5V, I _D = 15A	-	91	-	S

Dynamic Characteristics

C _{iss}	Input Capacitance	.,	V _{DS} = 20V, V _{GS} = 0V, f = 1MHz		2935	-	pF
Coss	Output Capacitance				340	-	pF
C _{rss}	Reverse Transfer Capacitance	1 - 11/11/12			260	-	pF
R_g	Gate Resistance	f = 1MHz	f = 1MHz		1.8	-	Ω
$Q_{g(ToT)}$	Total Gate Charge at 10V	$V_{GS} = 0$ to 10V	V _{DD} = 20V	-	60	78	nC
Q _{g(5)}	Total Gate Charge at 5V	$V_{GS} = 0$ to 5V	I _D = 15A	-	32	42	nC
Q_{gs}	Gate to Source Gate Charge		I _g =1mA	-	7.5	-	nC
Q_{gd}	Gate to Drain "Miller" Charge			-	13	-	nC

Electrical Characteristics $T_C = 25^{\circ}C$ unless otherwise noted

Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
Switch	ing Characteristics					

t _{on}	Turn-On Time		-	-	34	ns
$t_{d(on)}$	Turn-On Delay Time		1	12	-	ns
t _r	Rise Time	$V_{DD} = 20V, I_D = 15A,$	1	10	-	ns
t _{d(off)}	Turn-Off Delay Time	$V_{GS} = 10V, R_{GEN} = 6\Omega$	-	43	-	ns
t _f	Fall Time		-	7	-	ns
t _{off}	Turn-Off Time		-	-	80	ns

Drain-Source Diode Characteristics

V	Source to Drain Diode Voltage	I _{SD} = 2A	-	0.7	1.2	V
V_{SD}	Source to Drain Diode Voltage	I _{SD} = 15A	-	0.8	1.3	V
t _{rr}	Reverse Recovery Time	-I _F = 15A, dI _{SD} /dt = 100A/μs	-	25	33	ns
Q _{rr}	Reverse Recovery Charge		1	14	19	nC

1: Starting T_J = 25°C, L = 0.11mH, I_{AS} = 40A, V_{DD} = 36V during inductor charging and V_{DD} = 0V during the time in Avalanche.

This product has been designed to meet the extreme test conditions and environment demanded by the automotive industry. For a copy of the requirements, see AEC Q101 at: http://www.aecouncil.com/
All Fairchild Semiconductor products are manufactured, assembled and tested under ISO9000 and QS9000 quality systems certification.

175

150

Typical Characteristics 120 CURRENT LIMITED BY PACKAGE ID, DRAIN CURRENT (A) 90 V_{GS} = 10V 60 30 0.0

0

25

50

Figure 1. Normalized Power Dissipation vs Case **Temperature**

75

T_C, CASE TEMPERATURE(°C)

100

125

150

0

25

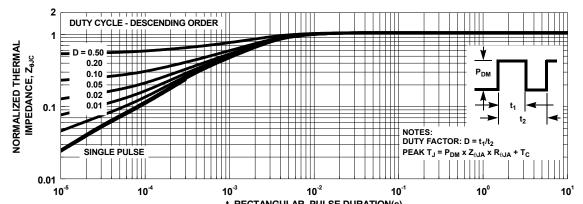
Figure 2. Maximum Continuous Drain Current vs **Case Temperature**

100

T_C, CASE TEMPERATURE(°C)

125

75



t, RECTANGULAR PULSE DURATION(s)
Figure 3. Normalized Maximum Transient Thermal Impedance

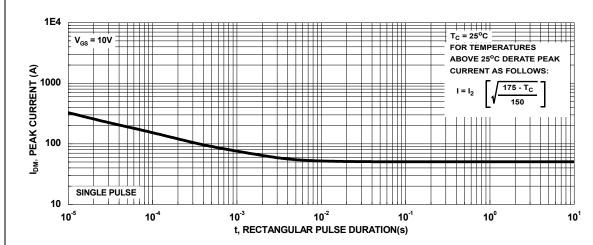


Figure 4. Peak Current Capability

Typical Characteristics

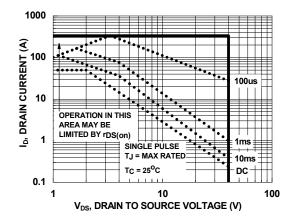
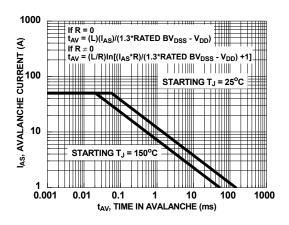


Figure 5. Forward Bias Safe Operating Area



NOTE: Refer to Fairchild Application Notes AN7514 and AN7515

Figure 6. Unclamped Inductive Switching

Capability

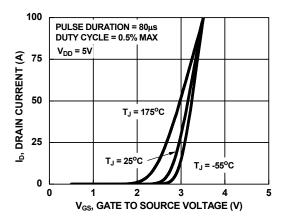


Figure 7. Transfer Characteristics

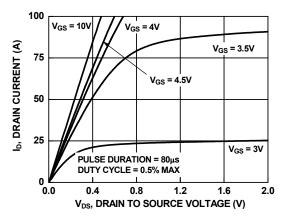


Figure 8. Saturation Characteristics

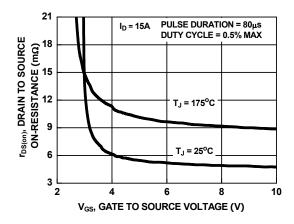


Figure 9. Drain to Source On-Resistance Variation vs Gate to Source Voltage

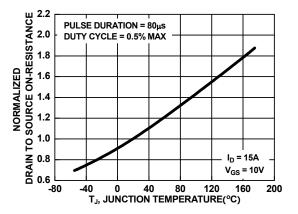


Figure 10. Normalized Drain to Source On Resistance vs Junction Temperature

Typical Characteristics

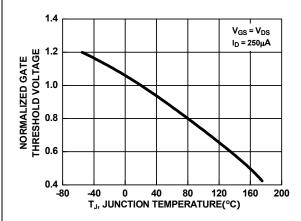


Figure 11. Normalized Gate Threshold Voltage vs Junction Temperature

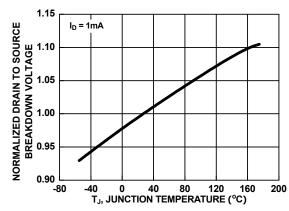


Figure 12. Normalized Drain to Source Breakdown Voltage vs Junction Temperature

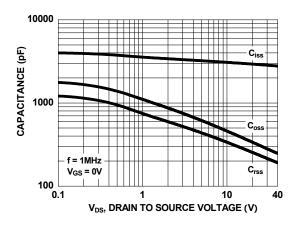


Figure 13. Capacitance vs Drain to Source Voltage

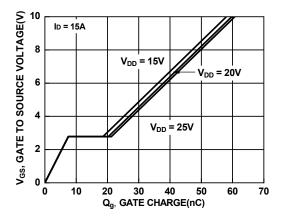


Figure 14. Gate Charge vs Gate to Source Voltage





TRADEMARKS

The following includes registered and unregistered trademarks and service marks, owned by Fairchild Semiconductor and/or its global subsidiaries, and is not intended to be an exhaustive list of all such trademarks.

2Cool™ AccuPower™ Auto-SPM™ AX-CAP™* BitSiC® Build it Now™ CorePLUS™ CorePOWER™

 $CROSSVOLT^{\text{TM}}$ $\mathsf{CTL}^{\mathsf{TM}}$ Current Transfer Logic™ DEUXPEED® Dual Cool™ EcoSPARK® EfficentMax™ ESBC™

 $\mathsf{Fairchild}^{\mathbb{R}}$ Fairchild Semiconductor® FACT Quiet Series™

FACT[®] FAST[®] FastvCore™ FETBench™ FlashWriter® FPS™ F-PFS™ FRFET®

Global Power ResourceSM Green FPS™ Green FPS™ e-Series™

 $\mathsf{G} max^\mathsf{TM}$ GTO™ IntelliMAX™ ISOPLANAR™ MegaBuck™ MICROCOUPLER™ MicroFET™ MicroPak™ MicroPak2™ MillerDrive™

MotionMax™ Motion-SPM™ mWSaver™ OptiHiT™ OPTOLOGIC®

OPTOPLANAR®

PDP SPM™ Power-SPM™ PowerTrench® PowerXS™

Programmable Active Droop™ QFET®

QS™

Quiet Series™ RapidConfigure™

Saving our world, 1mW/W/kW at a time™ SignalWise™

SmartMax™ SMART START™ SPM[®] STEALTH™ SuperFET®

SuperSOT™-3 SuperSOT™-6 SuperSOT™-8 SupreMOS® SyncFET™ Sync-Lock™

SYSTEM ®* 5GENERAL

The Power Franchise®

The Right Technology for Your Success™

wer * franchise TinyBoost™ TinyBuck™ TinyCalc™ TinyLogic[®] TINYOPTO™ TinyPower™ TinyPWM™ TinyWire™ TranSiC[®] TriFault Detect™ TRUECURRENT®* μSerDes™

UHC® Ultra FRFET™ UniFET™ VCX™ VisualMax™ XSTM

*Trademarks of System General Corporation, used under license by Fairchild Semiconductor.

DISCLAIMER

DISCLAIMEN
FAIRCHILD SEMICONDUCTOR RESERVES THE RIGHT TO MAKE CHANGES WITHOUT FURTHER NOTICE TO ANY PRODUCTS HEREIN TO IMPROVE RELIABILITY, FUNCTION, OR DESIGN. FAIRCHILD DOES NOT ASSUME ANY LIABILITY ARISING OUT OF THE APPLICATION OR USE OF ANY PRODUCT OR CIRCUIT DESCRIBED HEREIN; NEITHER DOES IT CONVEY ANY LICENSE UNDER ITS PATENT RIGHTS, NOR THE RIGHTS OF OTHERS. THESE SPECIFICATIONS DO NOT EXPAND THE TERMS OF FAIRCHILD'S WORLDWIDE TERMS AND CONDITIONS, SPECIFICALLY THE WARRANTY THESE SPECIFICATIONS THESE SPECIFICATIONS DO NOT EXPAND THE TERMS OF FAIRCHILD'S WORLDWIDE TERMS AND CONDITIONS, SPECIFICALLY THE WARRANTY THEREIN. WHICH COVERS THESE PRODUCTS

LIFE SUPPORT POLICYFAIRCHILD'S PRODUCTS ARE NOT AUTHORIZED FOR USE AS CRITICAL COMPONENTS IN LIFE SUPPORT DEVICES OR SYSTEMS WITHOUT THE EXPRESS WRITTEN APPROVAL OF FAIRCHILD SEMICONDUCTOR CORPORATION.

- Life support devices or systems are devices or systems which, (a) are intended for surgical implant into the body or (b) support or sustain life, and (c) whose failure to perform when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in a significant injury of the user.
- A critical component in any component of a life support, device, or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

ANTI-COUNTERFEITING POLICY

Fairchild Semiconductor Corporation's Anti-Counterfeiting Policy. Fairchild's Anti-Counterfeiting Policy is also stated on our external website, www.Fairchildsemi.com, under Sales Support.

Counterfeiting of semiconductor parts is a growing problem in the industry. All manufactures of semiconductor products are experiencing counterfeiting of their parts. Customers who inadvertently purchase counterfeit parts experience many problems such as loss of brand reputation, substandard performance, failed application, and increased cost of production and manufacturing delays. Fairchild is taking strong measures to protect ourselves and our customers from the proliferation of counterfeit parts. Fairchild strongly encourages customers to purchase Fairchild parts either directly from Fairchild or from Authorized Fairchild Distributors who are listed by country on our web page cited above. Products customers buy either from Fairchild directly or from Authorized Fairchild Distributors are genuine parts, have full traceability, meet Fairchild's quality standards for handing and storage and provide access to Fairchild's full range of up-to-date technical and product information. Fairchild and our Authorized Distributors will stand behind all warranties and will appropriately address and warranty issues that may arise. Fairchild will not provide any warranty coverage or other assistance for parts bought from Unauthorized Sources. Fairchild is committed to combat this global problem and encourage our customers to do their part in stopping this practice by buying direct or from authorized distributors.

PRODUCT STATUS DEFINITIONS Definition of Terms

Datasheet Identification	Product Status	Definition
Advance Information Formative / In Design		Datasheet contains the design specifications for product development. Specifications may change in any manner without notice.
Preliminary First Production		Datasheet contains preliminary data; supplementary data will be published at a later date. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve design.
No Identification Needed Full Production		Datasheet contains final specifications. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve the design.
Obsolete	Not In Production	Datasheet contains specifications on a product that is discontinued by Fairchild Semiconductor. The datasheet is for reference information only.

Rev. 155

Mouser Electronics

Authorized Distributor

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

Fairchild Semiconductor: FDD8453LZ_F085